

MTCA next generation

Chassis Cooling – a hot topic



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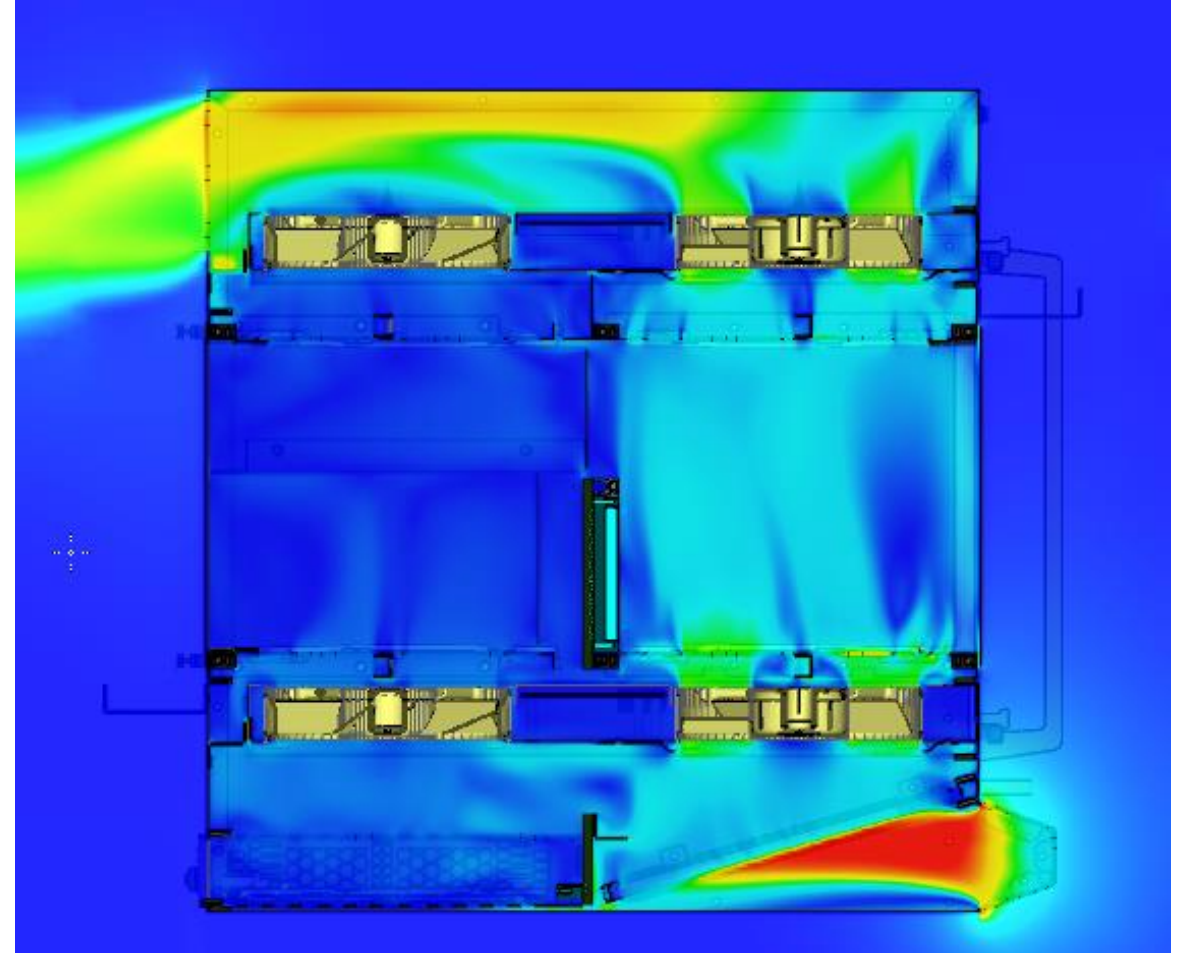
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December 02, 2020
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nVent / Schroff GmbH



Agenda

- Motivation / Starting point
- MTCA.4 crate cooling today
- Going beyond the current power limits
- Simulation model
- Calculation of required air flow
- Simulation results
- Conclusion



Motivation / Starting point

- MTCA currently limits the electrical power to the AMC to 80 W
- MTCA.4 limits the power to the RTM to 30 W (is deducted from the AMC power)
- Future applications require modules with more electrical power for latest processors and FPGAs
- A PICMG working group has been established to address this issues
- Preliminary goal:
 - AMC maximum electrical power 200W
 - RTM maximum electrical power 50W (is deducted from the AMC power)
 - Crate total power electrical budget 2000 W
- Also, the crate cooling system needs to be adapted

Presenting first thermal simulation results, which addresses the need of more cooling.

MTCA.4 as it is today

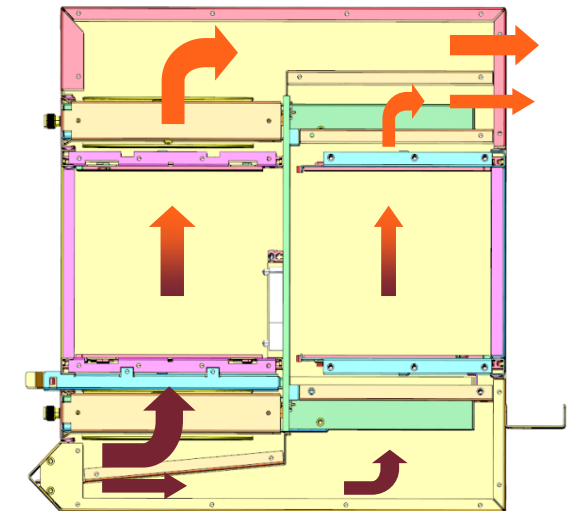
MicroTCA.4 crate, 9 U, 84 HP, for 12 double mid-size AdvancedMC modules, 2 MCHs, 4PMs



- 1 Upper Cooling Unit (CU1)
- 2 Lower Cooling Unit (CU2)
- 3 Air filter
- 4 ESD Wrist Strap Terminal
- 5 Cable Tray
- 6 Backplane
- 7 Card cage

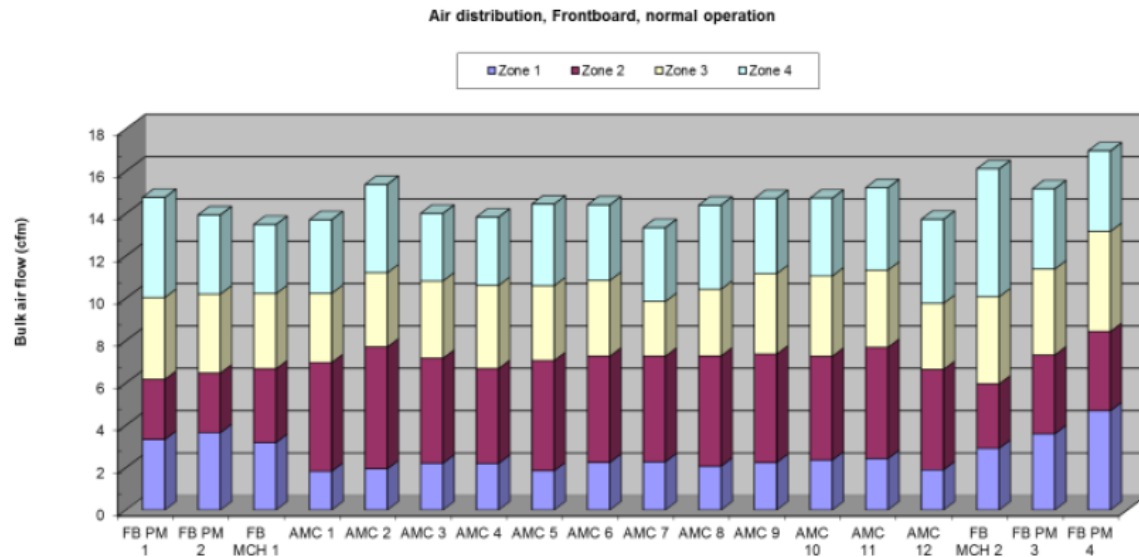


- 8 Rear card cage
- 9 Cable Tray
- 10 Ground Terminal

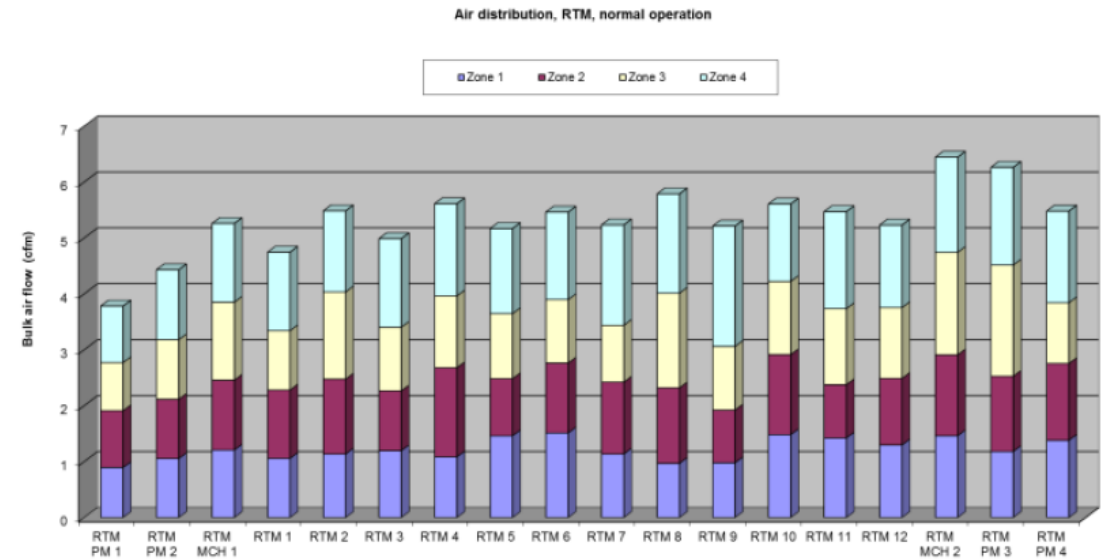


MTCA.4 as it is today

- AMC slot 1: 24.3 m³/h
 - cooling capability (at $\Delta T=12k$) ~ 88 W

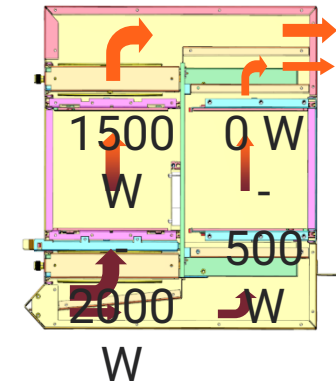
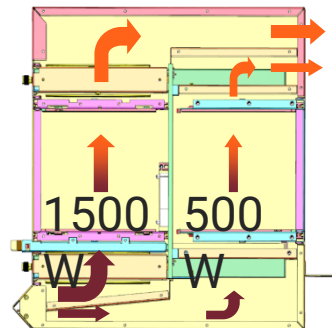
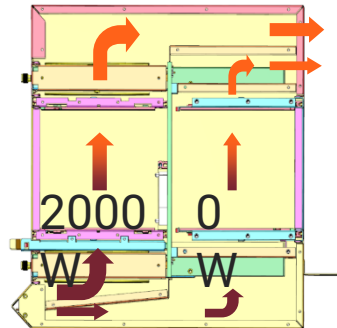


- RTM slot 7: 12.1 m³/h
 - cooling capability (at $\Delta T=12k$) ~ 44 W



Going beyond the current Power limits

- Simulation have been carried out to determine the cooling capabilities with different fan configurations
- Total electrical power in the shelf limited to 2000W
- Cooling load scenarios:
 - All electrical power consumed on the AMCs
 - => Front card cage: 2000 W cooling
 - => Rear Card cage: 0 W cooling
 - RTMs consume max. power of 30 W / 50 W
 - => Front card cage: ~ 1500 W cooling
 - => Rear Card cage: ~ 500 W cooling
 - Mixed cooling load
 - => Front card cage: ~ 1500 W – 2000 W cooling
 - => Rear Card cage: 0 W ... ~ 500 W cooling
- Chassis cooling system needs to be able to handle all configuration



Simulation model: Crate

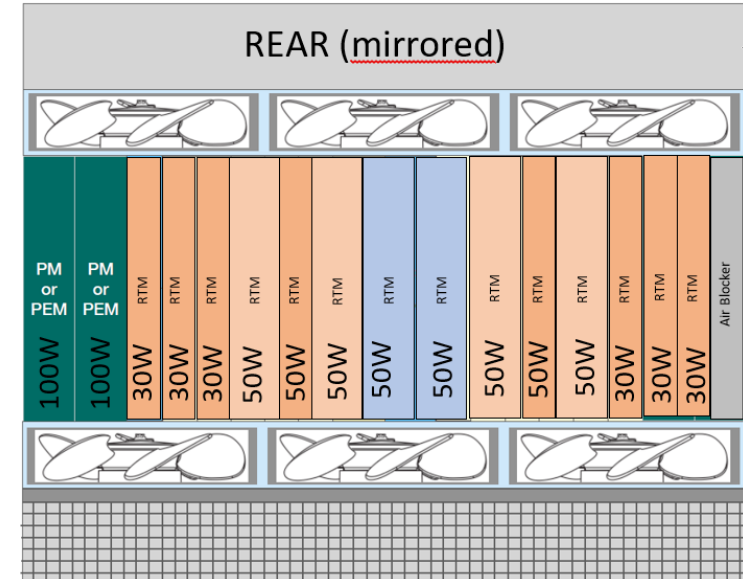
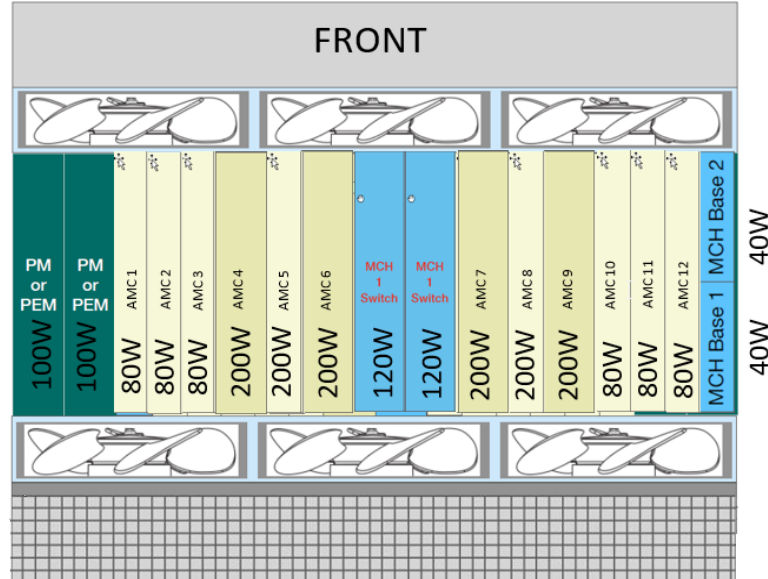
➤ Several cooling configurations have been simulated

- Push-Pull cooling, similar to existing 12-Slot crate
- Pull cooling (fans at air exhaust at the top rear of the crate), without air guidance
- Pull cooling (fans at air exhaust at the top rear of the crate), with air guidance

➤ Constraints:

- Max. power consumption per Cooling Unit 200 W
- Use of 12 V fans to stay compatible with 12V PP

➤ Simulation model:

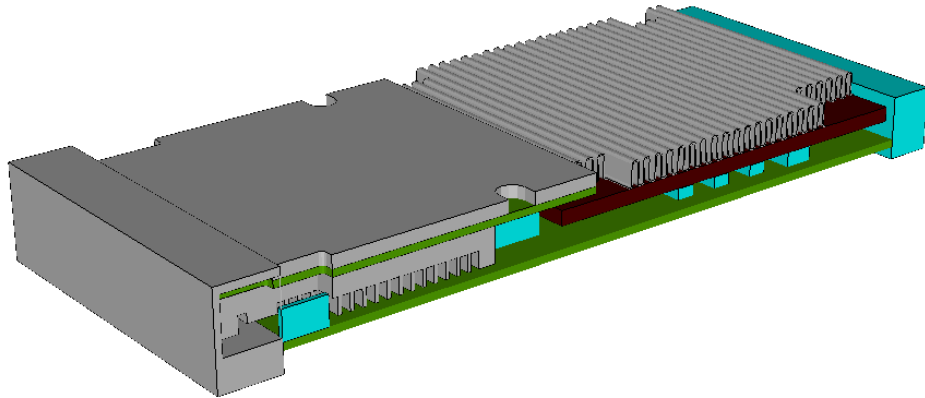


Simulation model: Modules

➤ Board models used for the simulation

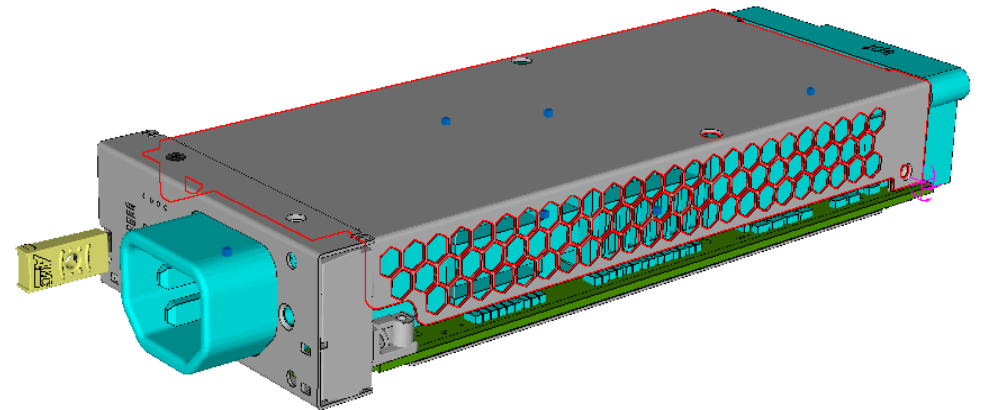
➤ Model for a Mid Size Module (AMC and RTM)

- High air impedance
- Used in previous simulations



➤ Model for Full Size Module (AMC and RTM)

- High air impedance
- Used in previous simulations



Calculation of required air flow

➤ Formular used to calculate required air flow:

➤ **$V = 3.3 \times P / \Delta T$**

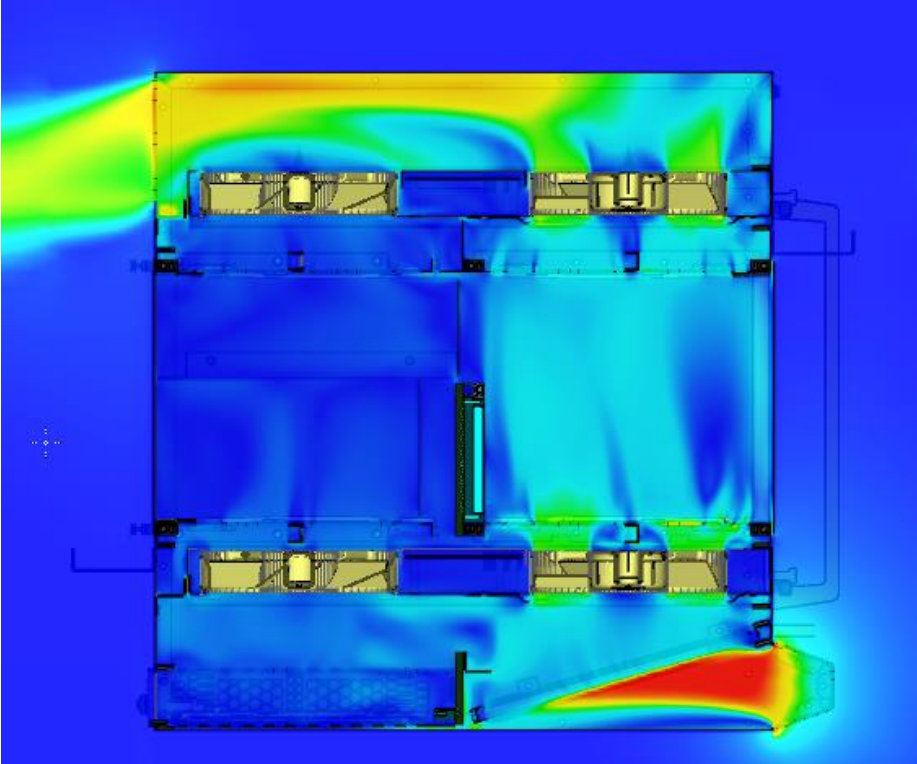
- V = Air Flow in m³/h
- P = Power required by the Module
- ΔT = allowed temperature rise in the module, typically we use 12K...15K
- 3.3 = coefficient

➤ **Example:**

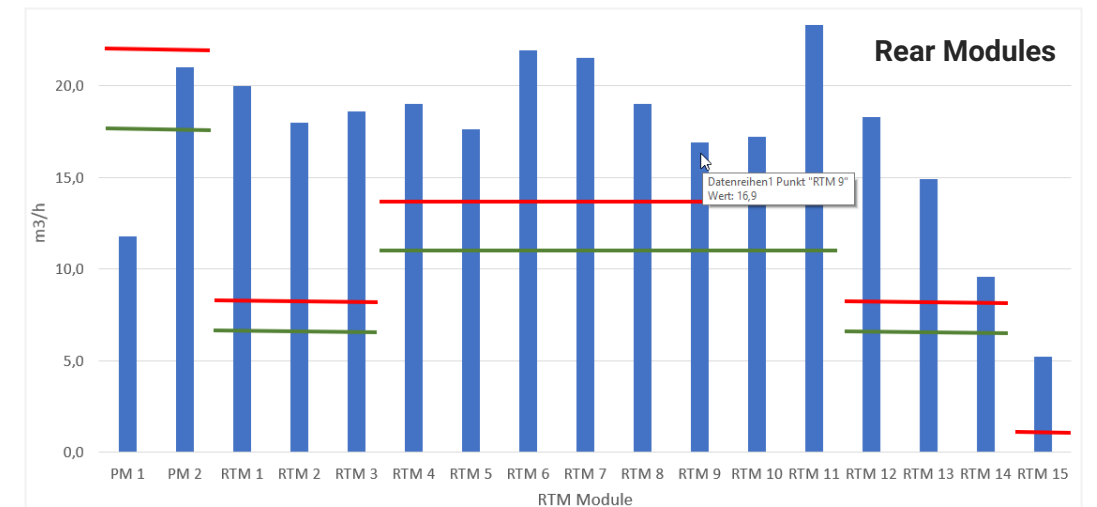
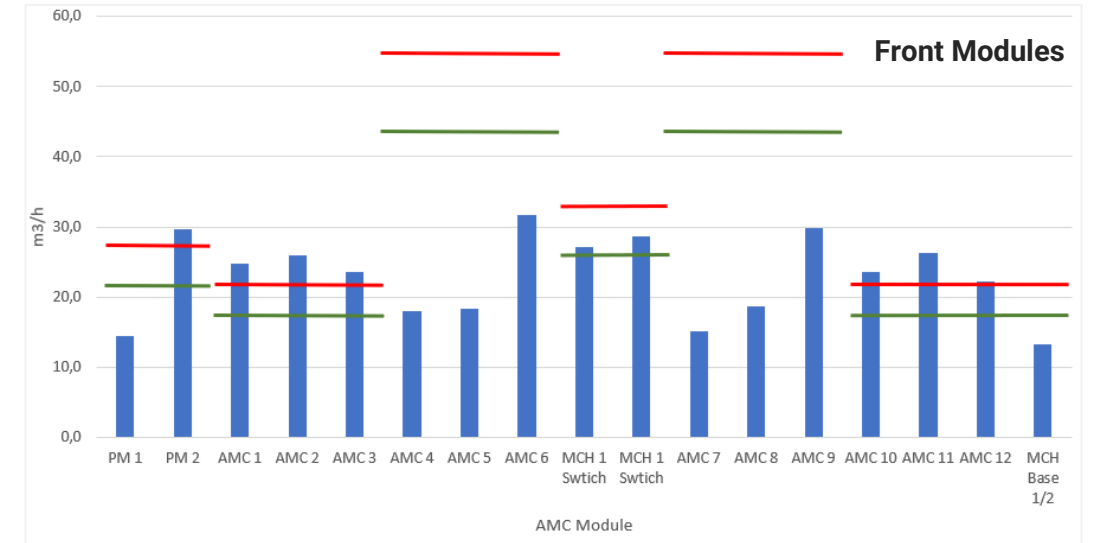
- AMC with 80 W power consumption: $V = 3.3 \times 80 \text{ W} / 12\text{K} = 22 \text{ m}^3/\text{h}$
 $V = 3.3 \times 80 \text{ W} / 15\text{K} = 17.6 \text{ m}^3/\text{h}$
- AMC with 200 W power consumption: $V = 3.3 \times 200 \text{ W} / 12\text{K} = 55 \text{ m}^3/\text{h}$
 $V = 3.3 \times 200 \text{ W} / 15\text{K} = 44 \text{ m}^3/\text{h}$

Simulation result, Push-Pull

- Push-Pull cooling, Air flow distribution per slot, like existing 12-Slot crate



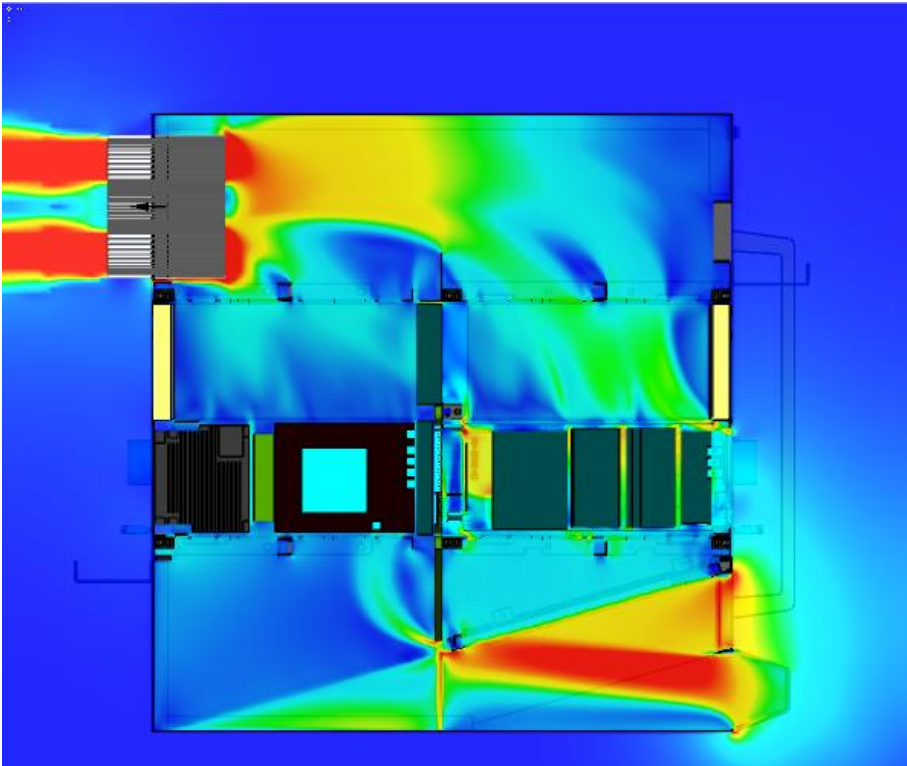
Crate side view



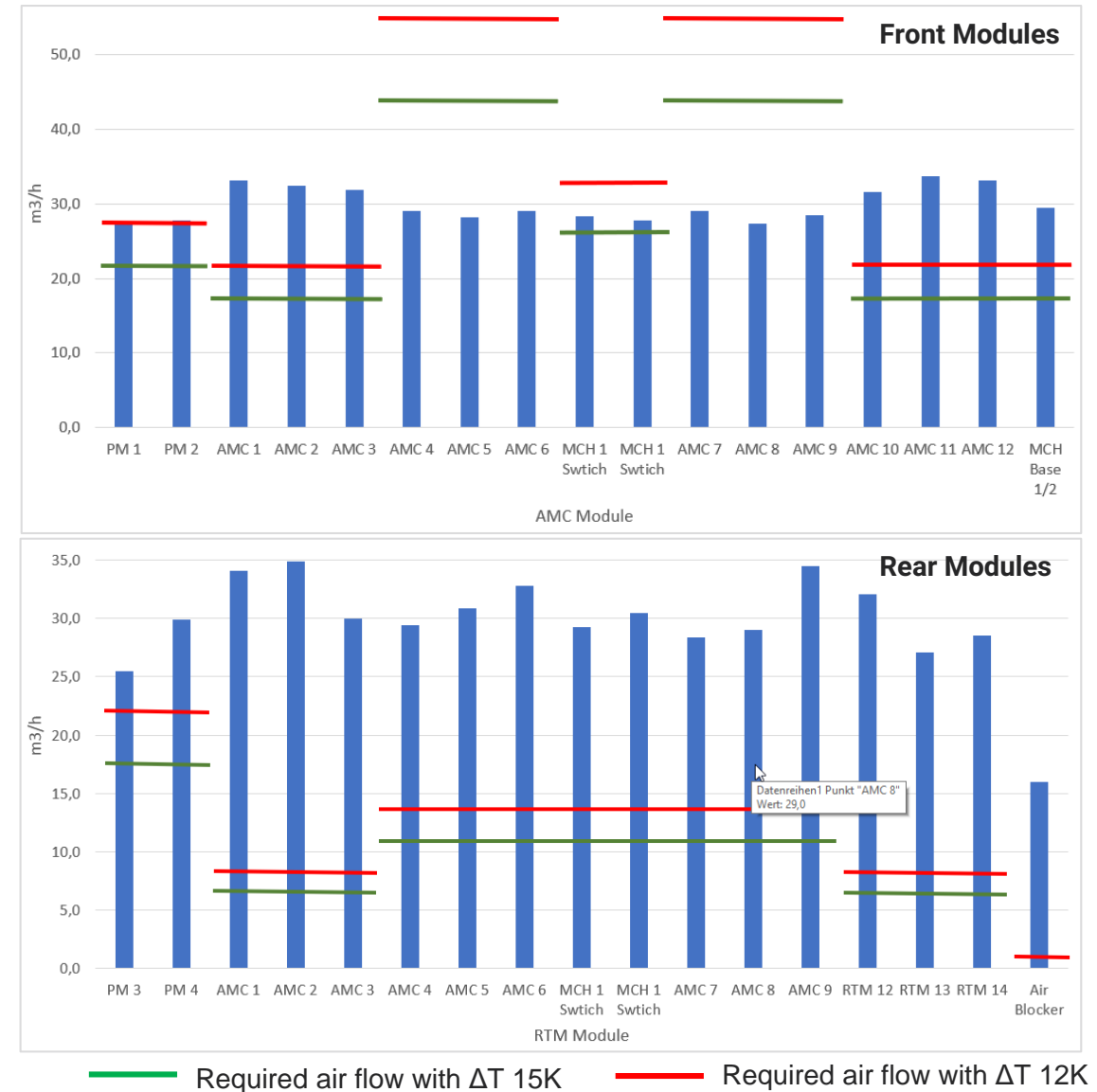
— Required air flow with ΔT 15K — Required air flow with ΔT 12K

Simulation result, Pull, without air guidance

- Pull cooling (fans at air exhaust at the top rear of the crate), without air guidance

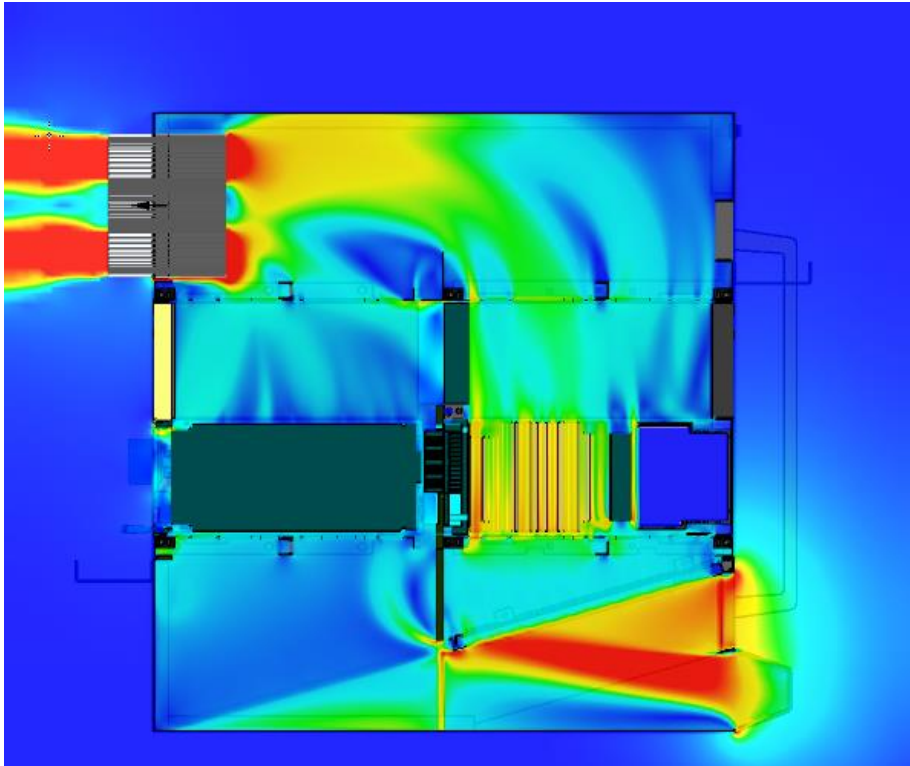


Crate side view

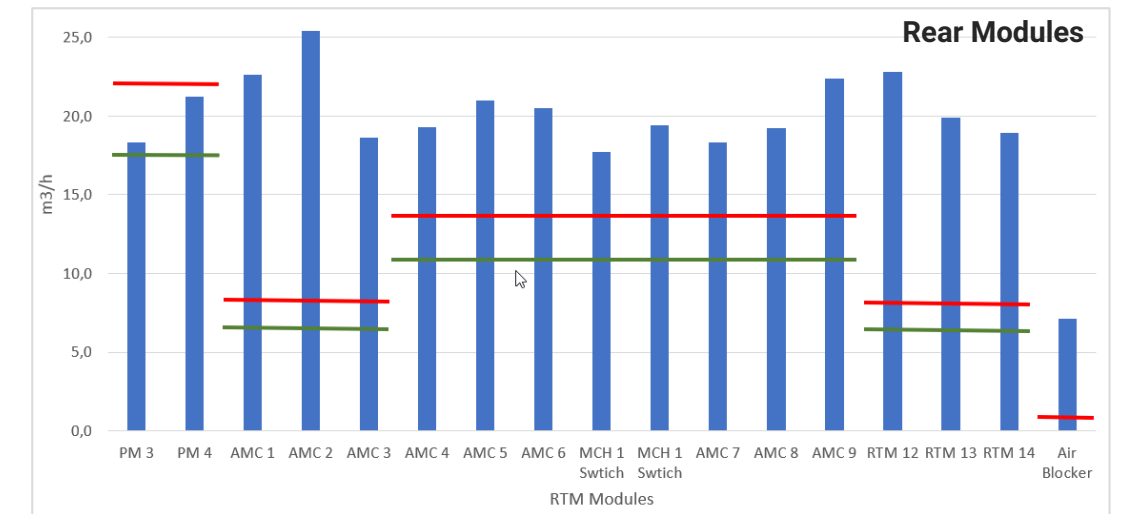
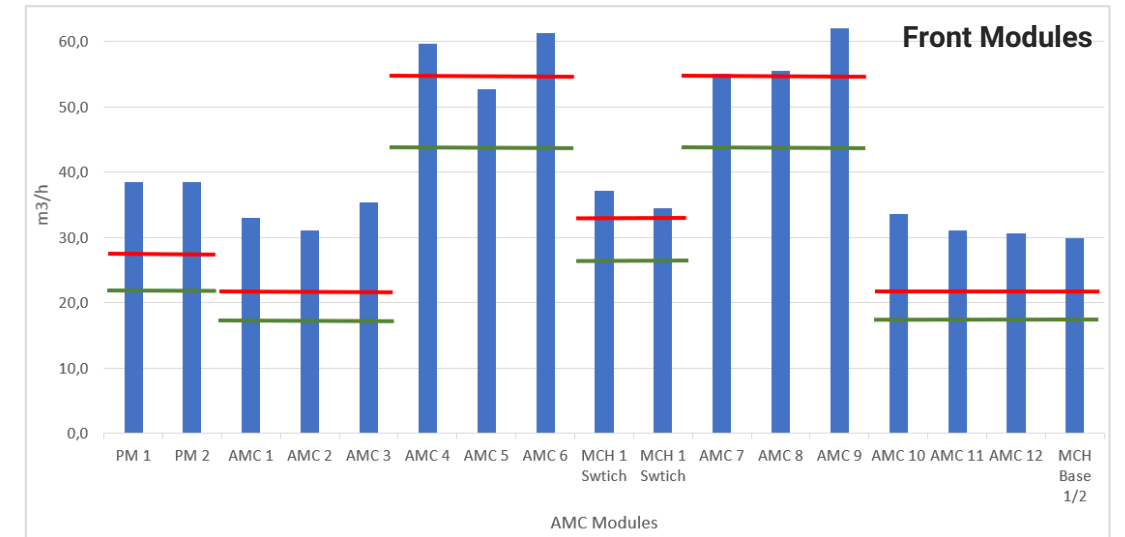


Simulation result, Pull, with air guidance

- Pull cooling (fans at air exhaust at the top rear of the crate), with air guidance



Crate side view



— Required air flow with ΔT 15K — Required air flow with ΔT 12K

Conclusion

- Simulation results show that cooling of High-Power Modules of up to 200 W is possible
- Pull fan configuration seems to be more suitable than push-pull fan arrangement
- Required fan power is an issue, needs careful selection of fans
- Also fan acoustic noise needs to be considered
- Challenge to balance the air between front / rear and between the slots
- Careful Air guidance / blockage required to guide the air to High-Power Module slots

Thank you!

